

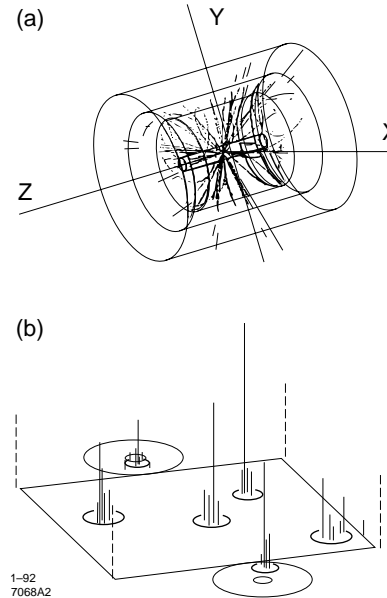
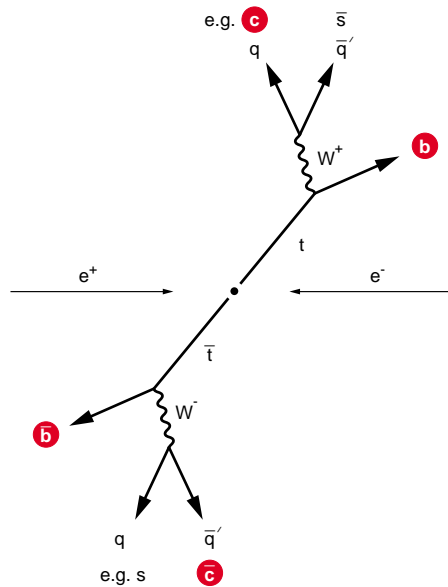
A CCD Vertex Detector for the future TeV-scale e^+e^- Linear Collider

CERN Workshop
Chris Damerell
28 November 2001

- Luminosity $3.4 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ at 500 GeV
 - Physics requirements
 - Background conditions
 - Generic vertex detector design
 - CCD vertex detectors – track record for physics
 - LC vertex detector – CCD option
 - R&D programme – status and outlook
 - World-wide LC detector R&D - coordination

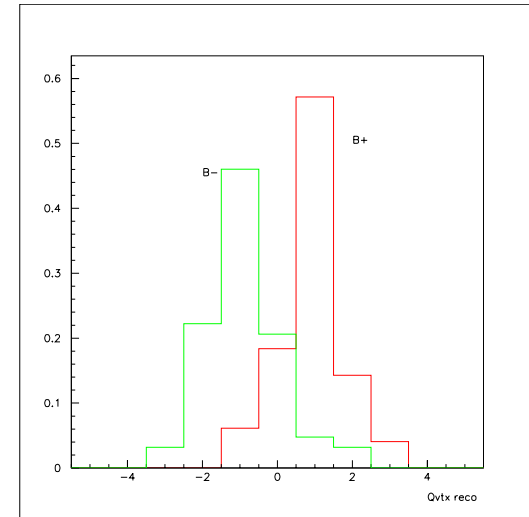
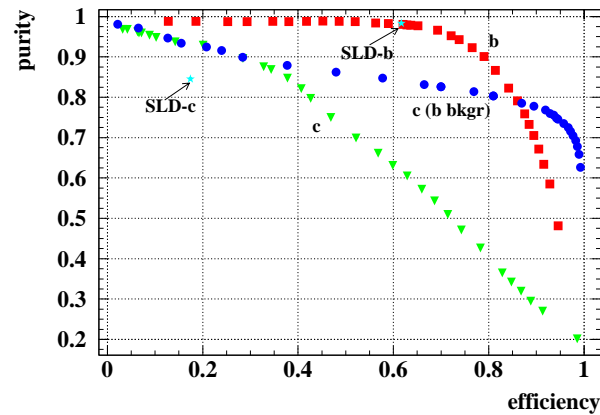
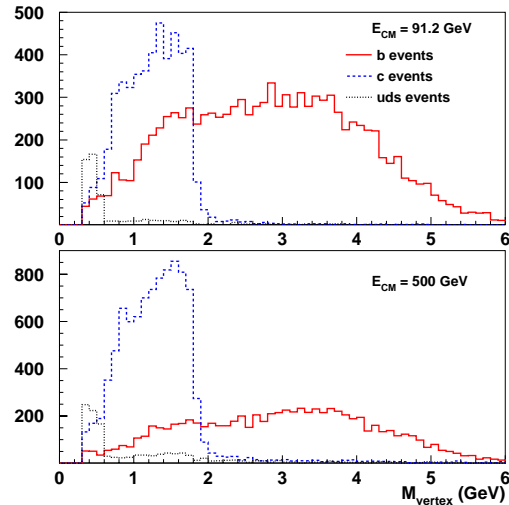
Physics Requirements

- At TeV scale, multi-jet processes for SM and beyond SM physics



- Need high efficiency/purity for b and charm tagging
- Use of vertex charge and charge dipole to distinguish b from \bar{b} , c from \bar{c}
- This requires topological vertex reconstruction to level of PV vs SV/TV, hence high efficiency for track assignment to PV or SV/TV
- SLD detector approaches the desired performance for b , but falls short for charm
- Need untriggered deadtimeless operation: subtle event signatures possible
- Don't need to read every BX, but fast enough to control background hit density

- Exciting synergy with energy flow calorimetry (60×10^6 elements)
- P_T -corrected mass of SLD approach may be sharpened by inclusion of π^0 s



- Partial reconstruction of missing neutrinos may enhance determination of energy of these 'sub-standard' jets
- All this is in its infancy; remember that synergy between vertexing and electron polarisation at SLD was initially dismissed

Background Conditions

- Hadronic event rate < 1 Hz (compare pp at same luminosity) so radiation environment is negligible
- Not quite:
 - Beam power 11 MW/beam \Rightarrow significant but remote neutron sources
 - e^+e^- production from beam-beam interaction \Rightarrow significant small-radius background; mostly confined by 4T solenoid
- Few $\times 10^9$ n/cm² and few 10s of krad ionising radiation in detector lifetime
 \Rightarrow CCDs, MAPS, DEPFET pixels are all candidates

[HAPS provides overkill in speed/radiation tolerance, but excessive pixel size and thickness]

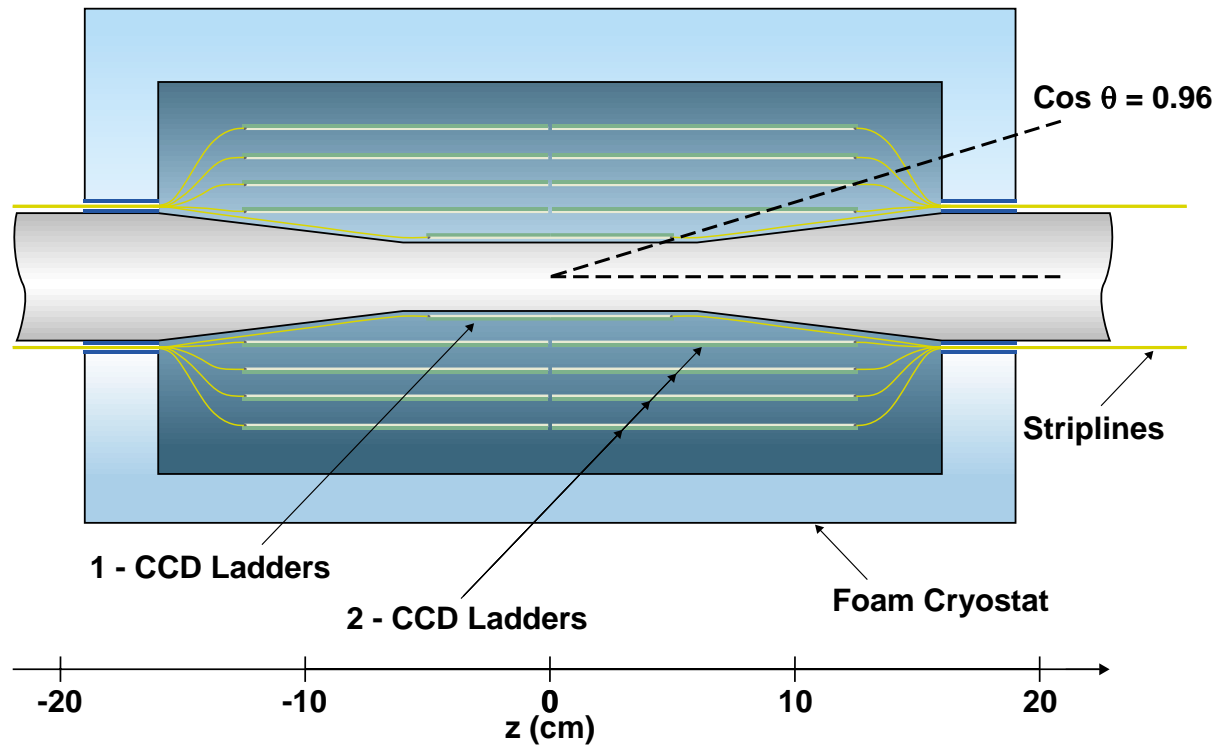
- Readout time requirement from background hit rate on Layer 1. Need $\lesssim 10/\text{mm}^2$

NLC: readout between bunch trains (8 ms) is adequate

TESLA: need $\sim 50 \mu\text{s}$ readout time during bunch train (~ 20 frames during 1 ms, at 200 ms period)

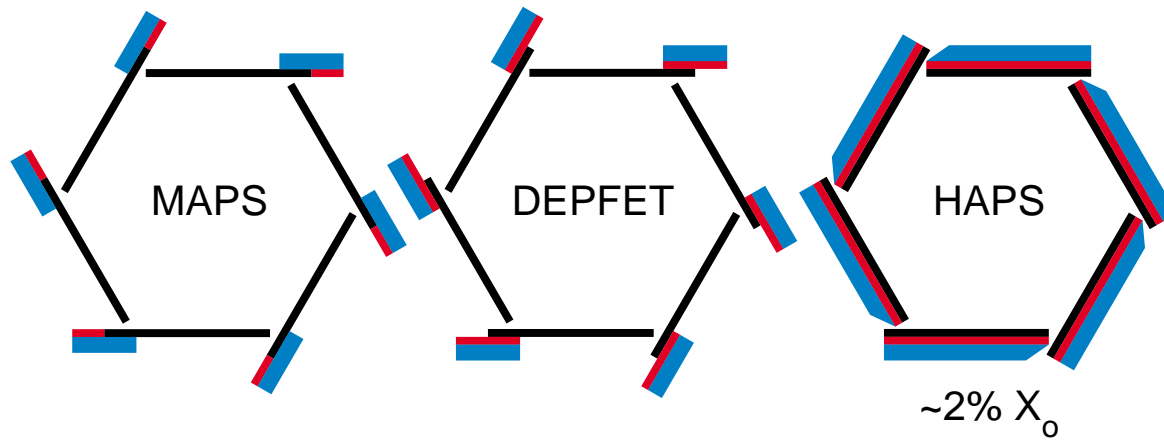
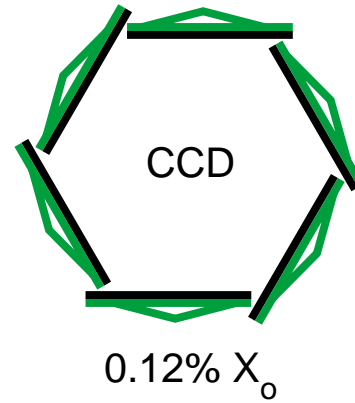
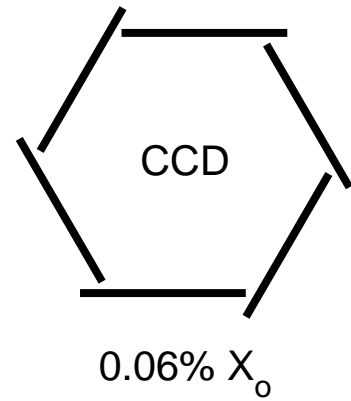
[average readout rate for both options is ~ 100 Hz reflecting similar design luminosity]

- Now almost unanimous agreement on optimal detector layout:



- Pixel-based (microstrips faded out in 1993)
- Concentric long barrels ('lampshade' variant still considered up to time of TESLA TDR.
Would make sense in context of a thick-layer fallback option)
- Measure space points with precision $< 5\mu\text{m}$ in each layer
- Layer thickness $\lesssim 0.1\% X_0$
- Layer 1 readout time $\lesssim 50\mu\text{s}$ required for TESLA
8 ms OK for NLC/JLC
(this became clear in November 1998)
- Modest radiation hardness
- While the goals are clear, the means to get there are not
- Very dynamic: 4 technologies being pursued (CCD, MAPS, DEPFET and HAPS)

- $r - \phi$ views



- Material requirements beyond active ladder ends are relatively unknown for all options

- If more than one technology achieves the above goals, decision will probably become clear on basis of **material budget**
 - This matters all the way to $|\cos \theta| = 0.996$ (LAT outer edge at 83 mrad)
[similar considerations relevant to TPC/silicon tracker comparison]
 - γ conversions and secondary interactions are dangerous for energy flow quality of forward jets
 - Mechanical supports need to provide $\sim 1 \mu\text{m}$ stability
 - Inner electronics material budget by no means quantified
 - Cables and optic fibres probably modest for all options
 - Cooling requirements could be decisive
- **Need full sized, fully functional prototype ladder before taking *any* technology seriously**
[the devil is in the details]
- **Meanwhile, important for all concerned to avoid overselling any option**

CCD Vertex Detectors Track Record for Physics

- Possibility for clean charm tagging was established by ACCMOR collaboration in early '80s
- Extended to the e^+e^- collider environment in SLD;

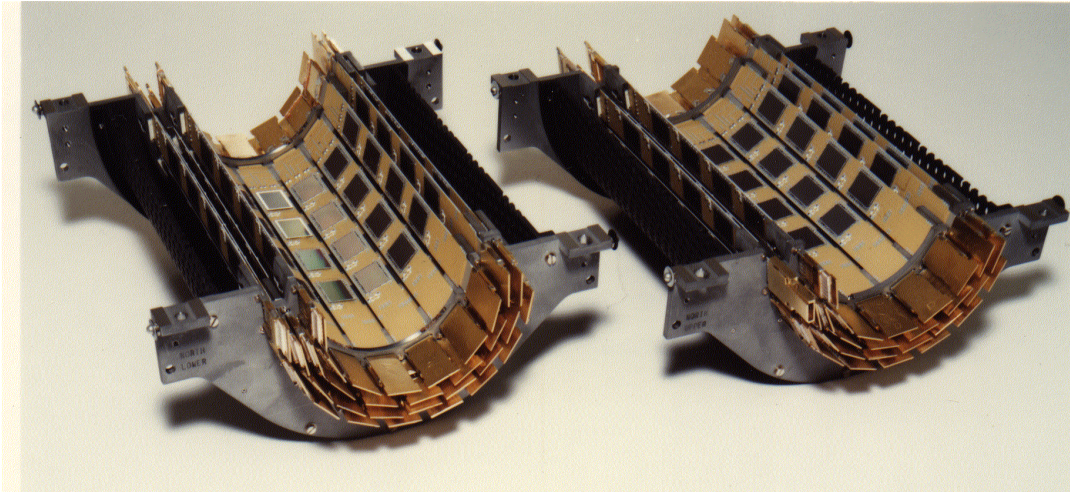
VXD2/VXD3

- Topological vertex reconstruction was the key to success in both experiments
- Novel track-based alignment techniques were essential in SLD

The SLD Vertex Detectors

VXD2

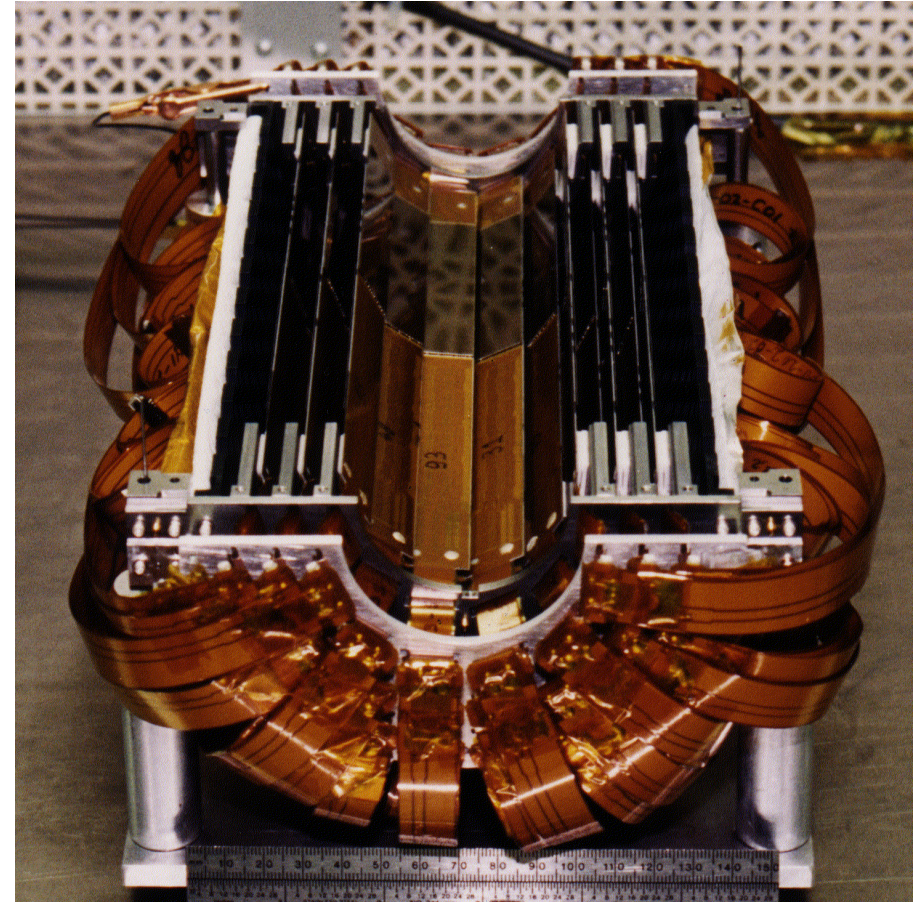
VXD3



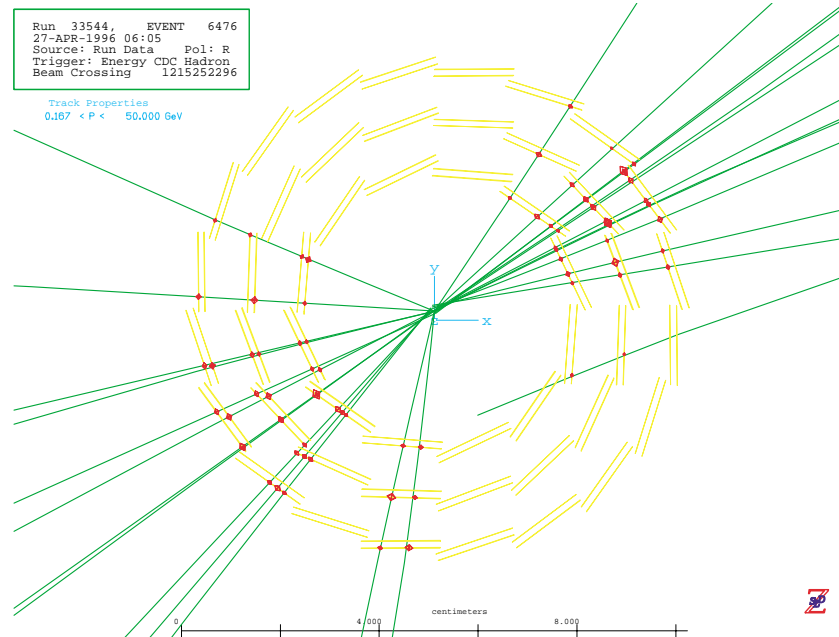
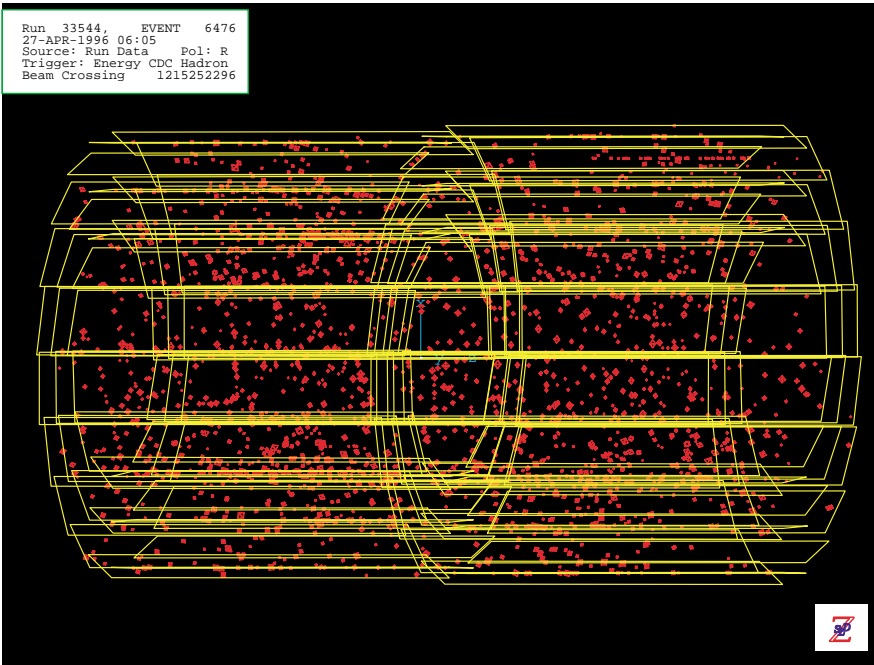
120 Mpixels

Proc 26th Int Conf on HEP, Dallas TX (1992)

307 Mpixels



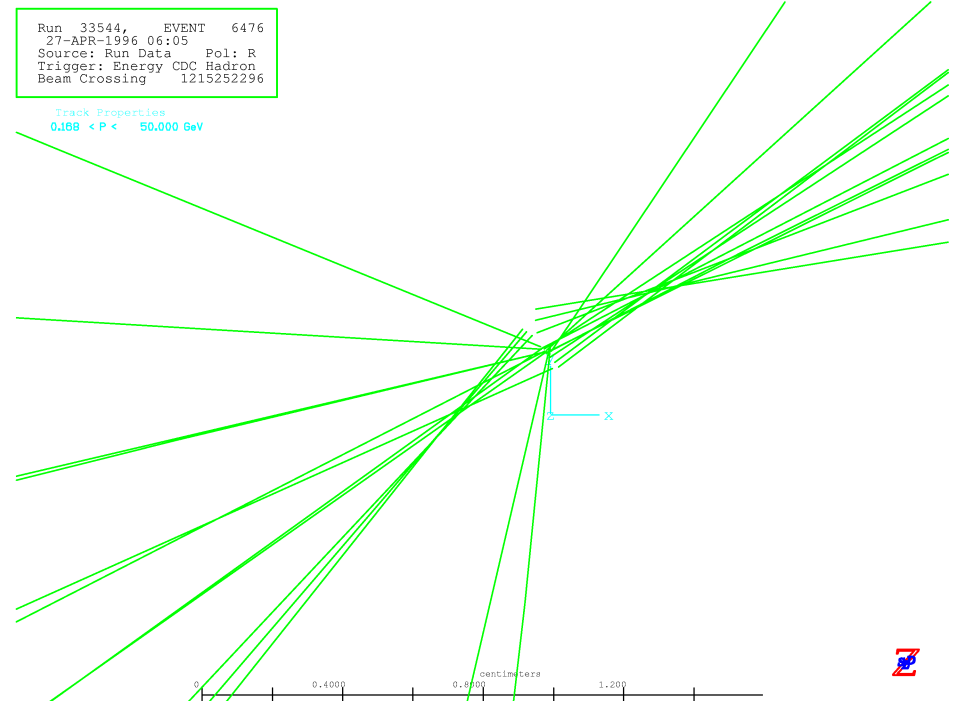
NIM A400 (1997) 287



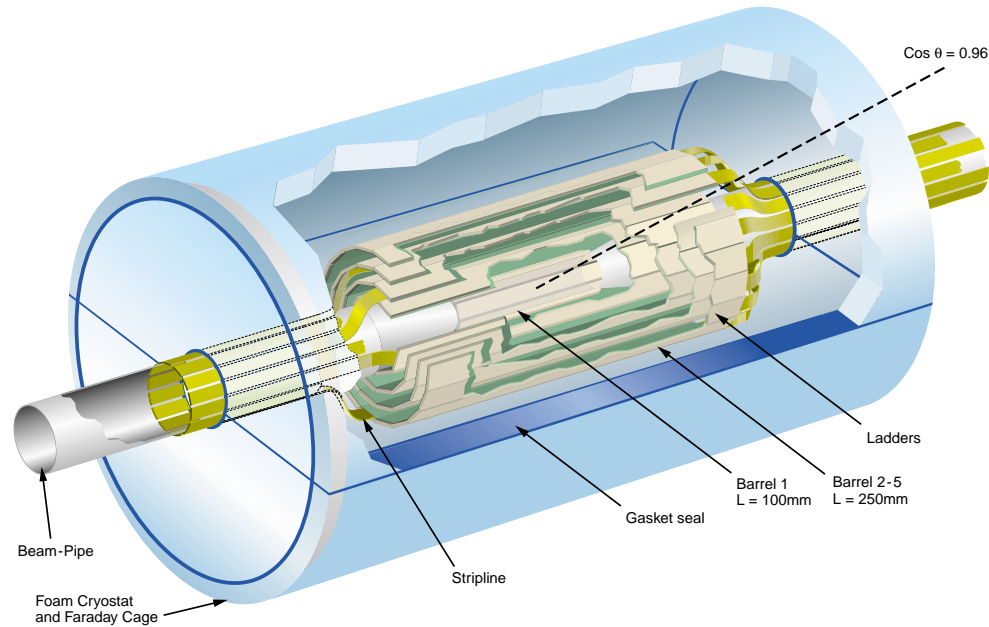
- Saved by shrinking microelectronics/fibre-optics
- Layer thickness 0.4% X_0 (from 1.2% X_0 in VXD2)
- Best imp param resolution of any LEP/SLC expt

$$\sigma_{\gamma\phi} = 9 \oplus \frac{33}{p \sin^{3/2} \theta} \mu\text{m}$$

$$\sigma_{\gamma z} = 17 \oplus \frac{33}{p \sin^{3/2} \theta} \mu\text{m}$$

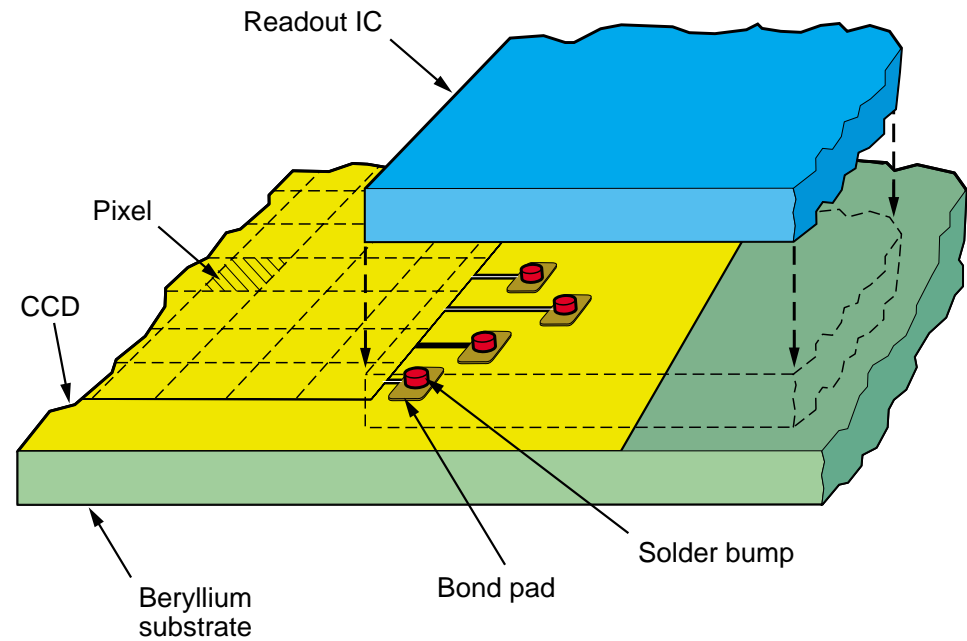
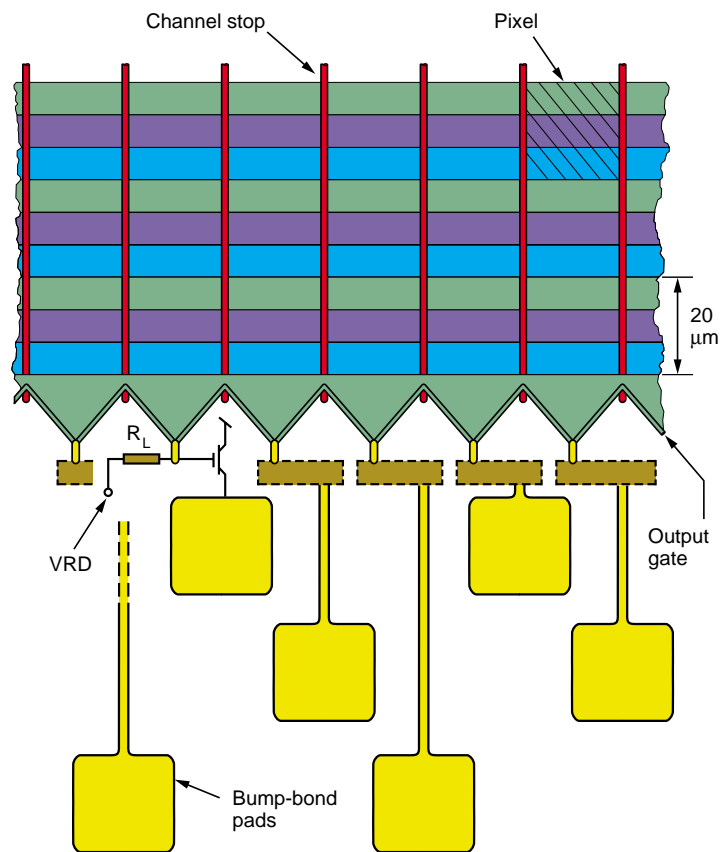


LC Vertex Detector CCD Option



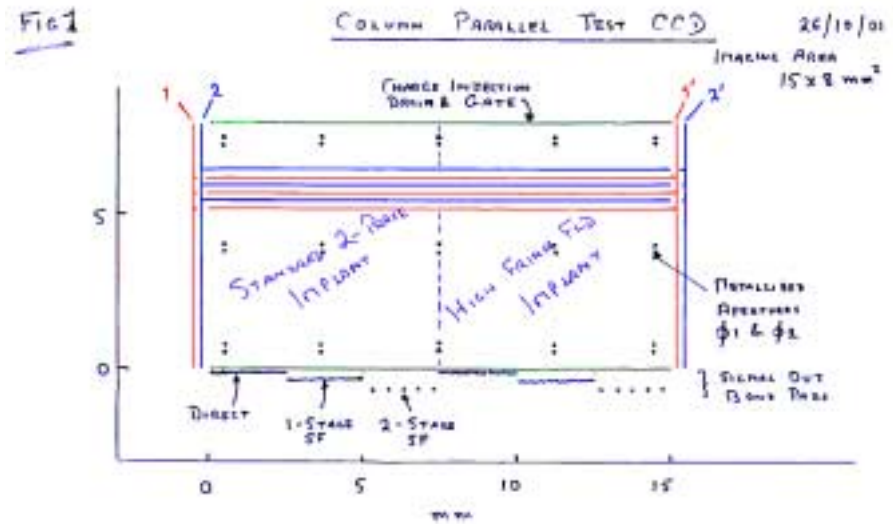
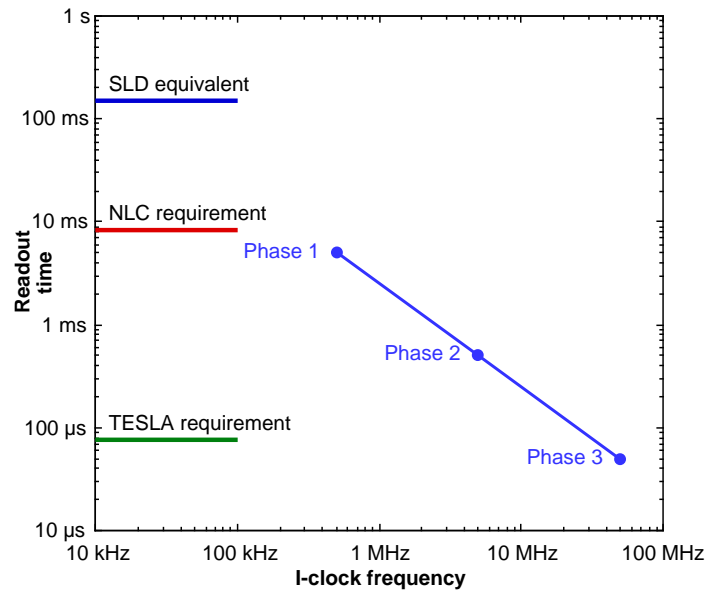
- Layer 1 radius 15 mm
- Layers 1-3 provide coverage to $|\cos \theta| = 0.96$
- Single CCD on Layer 1 ladder (10 cm length)
- 2 CCDs on Layer 2-5 (12.5 cm length)
- **Electrical connections (bias, drive, readout) only at ladder ends** outside volume for precision tracking
- **Stand-alone track reconstruction** – extremely important for measurement of jet energy
- 800 Mpixels (compared with 307 Mpixels for VXD3)

- Column parallel CCD connected to a deep submicron readout chip



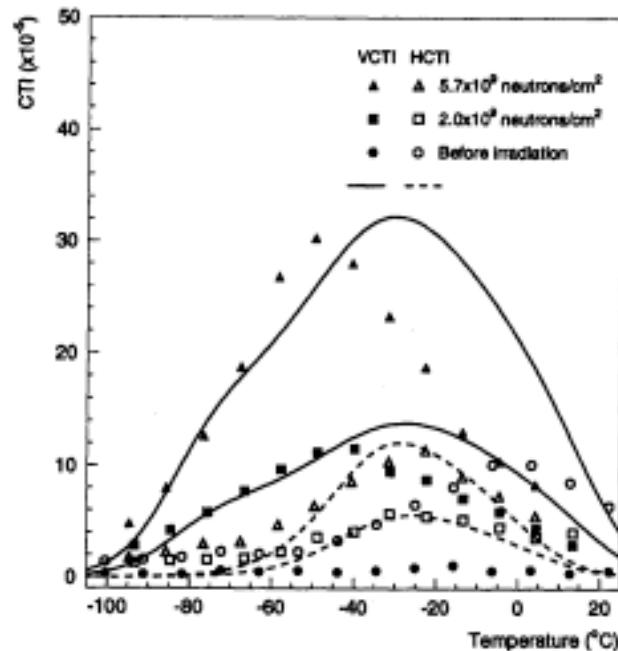
CCD R&D Status

- Proposal to PPESP of March 2001 was cautiously staged



- Has recently metamorphosed into a multi-faceted set of test CCDs which will explore all three phases in parallel
- Experience at MTech with XMM and other recent CCD designs is proving invaluable
- 'Dream team' of David Burt et al, Marcus French, Steve Thomas, Konstantin Stefanov, Tony Gillman...

- Column parallel ideally suited to real-time pipelined data sparsification
- Reduced clock voltages the key to acceptable power dissipation. Hope to retain massless gas cooling
- Test devices should be available by Summer 2002
- Radiation hardness – good news for CCDs



- Each technology has its list of possible show-stoppers. One for the CPCCD (recently solved) was the busline inductances. **More dangerous are the ones we don't know about!**

World-wide LC Detector R&D

- Accelerator GAN – there will only be one!
- May be two LC detectors, but essential to overcome regional focus in design and R&D
- Open access to meeting notes and design studies on Web – encourage information sharing and active collaboration

LCFI Collaboration: <http://hep.ph.liv.ac.uk/~green/lcfi/home.html>

- Not confined to LC; RHIC vertex detector R&D has a strong overlap – recent BNL workshop
- Document listing current activities, web sites and suggestions for enhanced coordination being prepared for ICFA Lab Directors Conference in February 2002
- Goal, when LC becomes a real project, is to ensure that nobody feels left out.